

NORYL™ RESIN PX0888

REGION ASIA

DESCRIPTION

NORYL PX0888 resin is a non-reinforced blend of polyphenylene ether (PPE) + polystyrene (PS). This grade exhibits very low moisture absorption, hydrolytic stability, dimensional stability, good foam adhesion, and property retention over a wide temperature range. NORYL PX0888 resin is inherently UL94 HB and is an excellent candidate for automotive interior applications such as instrument panels, audio components, speaker housings, and interior trim.

GENERAL INFORMATION	
Features	Hydrolytic Stability, Low Warpage, Amorphous, Low Shrinkage, Low Moisture Absorption, Low Specific Gravity, Dimensional stability, No PFAS intentionally added
Fillers	Unreinforced
Polymer Types	Polyphenylene Ether + PS (PPE+PS)
Processing Techniques	Injection Molding

INDUSTRY	SUB INDUSTRY
Automotive	Automotive Interiors

TYPICAL PROPERTY VALUES

Revision 20231109

PROPERTIES	TYPICAL VALUES	UNITS	TEST METHODS
MECHANICAL ⁽¹⁾			
Tensile Stress, yld, Type I, 50 mm/min	58	MPa	ASTM D638
Tensile Strain, brk, Type I, 50 mm/min	30	%	ASTM D638
Flexural Stress, yld, 2.6 mm/min, 100 mm span	93	MPa	ASTM D790
Flexural Modulus, 2.6 mm/min, 100 mm span	2350	MPa	ASTM D790
Hardness, Rockwell R	118	-	ASTM D785
IMPACT ⁽¹⁾			
Izod Impact, notched, 23°C	197	J/m	ASTM D256
Izod Impact, notched, -40°C	133	J/m	ASTM D256
THERMAL ⁽¹⁾			
HDT, 0.45 MPa, 6.4 mm, unannealed	129	°C	ASTM D648
HDT, 1.82 MPa, 6.4 mm, unannealed	127	°C	ASTM D648
CTE, 0°C to 100°C, flow	7.38E-05	1/°C	ASTM E831
PHYSICAL ⁽¹⁾			
Specific Gravity	1.04	-	ASTM D792
Water Absorption, (23°C/24hrs)	0.1	%	ASTM D570
Mold Shrinkage, flow, 3.2 mm ⁽²⁾	0.5 – 0.7	%	SABIC method
Melt Volume Rate, MVR at 300°C/2.16 kg	6	cm ³ /10 min	ISO 1133
INJECTION MOLDING ⁽³⁾			
Drying Temperature	105 – 110	°C	
Drying Time	3 – 4	Hrs	
Drying Time (Cumulative)	8	Hrs	

PROPERTIES	TYPICAL VALUES	UNITS	TEST METHODS
Maximum Moisture Content	0.02	%	
Melt Temperature	280 – 310	°C	
Nozzle Temperature	280 – 310	°C	
Front - Zone 3 Temperature	270 – 310	°C	
Middle - Zone 2 Temperature	260 – 305	°C	
Rear - Zone 1 Temperature	250 – 300	°C	
Mold Temperature	75 – 105	°C	
Back Pressure	0.3 – 0.7	MPa	
Screw Speed	20 – 100	rpm	
Shot to Cylinder Size	30 – 70	%	

- (1) The information stated on Technical Datasheets should be used as indicative only for material selection purposes and not be utilized as specification or used for part or tool design.
- (2) Measurements made from laboratory test coupon. Actual shrinkage may vary outside of range due to differences in processing conditions, equipment, part geometry and tool design. It is recommended that mold shrinkage studies be performed with surrogate or legacy tooling prior to cutting tools for new molded article.
- (3) Injection Molding parameters are only mentioned as general guidelines. These may not apply or may need adjustment in specific situations such as low shot sizes, large part molding, thin wall molding and gas-assist molding.

ADDITIONAL PRODUCT NOTES

No PFAS intentionally added: The grade listed in this document does not contain PFAS intentionally added during Seller's manufacturing process and is not expected to contain unintentional PFAS impurities. Each user is responsible for evaluating the presence of unintentional PFAS impurities.

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